


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ADG/22/13255	
1.3 Title of PCN	STU6NF10 (QD0A01): Activation of TFME (TongFu former Nantong Fujitsu) as Assembly and Final Testing Location	
1.4 Product Category	STU6NF10	
1.5 Issue date	2022-02-14	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	KRISZTINA NEMETH
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Mario ASTUTI
2.1.2 Marketing Manager	Michele SCUTO
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	Subcontractor TFME - China receiving Plant

4. Description of change

	Old	New
4.1 Description	ST Shenzhen - China	Subcontractor TFME - China
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Capacity Increase
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	Dedicated Finished Good Code
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7. Timing / schedule

7.1 Date of qualification results	2022-02-02
7.2 Intended start of delivery	2022-06-01
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	13255 Validation.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2022-02-14

9. Attachments (additional documentations)

13255 Public product.pdf
13255 Validation.zip
13255 Details.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STU6NF10	

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